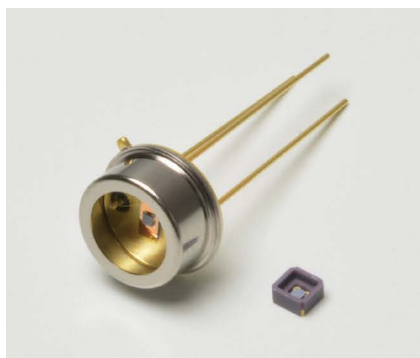


InAsSb photovoltaic detectors



P16114-011MN P16614-011CN

Infrared detector with high photosensitivity (up to 10 μm band)

The P16114-011MN and P16614-011CN are an infrared detector that have high sensitivity in the spectral band up to 10 μm . This high sensitivity has been achieved due to Hamamatsu unique crystal growth technology and process technology. By using a back-illuminated structure, the photosensitivity has been improved compared to the front-illuminated type. These products are an environmentally friendly infrared detector and do not use lead, mercury, or cadmium, which are substances restricted by the RoHS directive. These products replace conventional products containing these substances.

Features

- High sensitivity
- High-speed response
- High shunt resistance
- Compact, surface mount type ceramic package (P16614-011CN)
- Compatible with lead-free solder reflow (P16614-011CN)
- RoHS compliant (lead, mercury, cadmium free)

Applications

- Gas detection (SO_x , NO_x , NH_3 , O_3 , etc.)
- Radiation thermometers
- CO_2 laser monitor
- Mid infrared spectroscopy

Option (sold separately)

- Amplifier for infrared detector **C4159-01**

Structure

| Parameter | P16114-011MN | P16614-011CN | Unit |
|---------------------|--------------|--------------|---------|
| Window material | None | | - |
| Package | TO-5 | Ceramic | - |
| Photosensitive area | 0.7 × 0.7 | | mm |
| Field of view | 101 | 86 | degrees |

Absolute maximum ratings ($T_a=25\text{ }^\circ\text{C}$, unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|-------------------------|--------|--------------|------------------------|
| Reverse voltage | VR | 1 | V |
| Operating temperature*1 | Topr | -40 to +85 | $^\circ\text{C}$ |
| Storage temperature*1 | Tstg | -40 to +85 | $^\circ\text{C}$ |
| Incident light level | Pin | 1 | W/mm^2 |
| Soldering temperature | Tsol | 240 (once)*2 | $^\circ\text{C}$ |

*1: No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

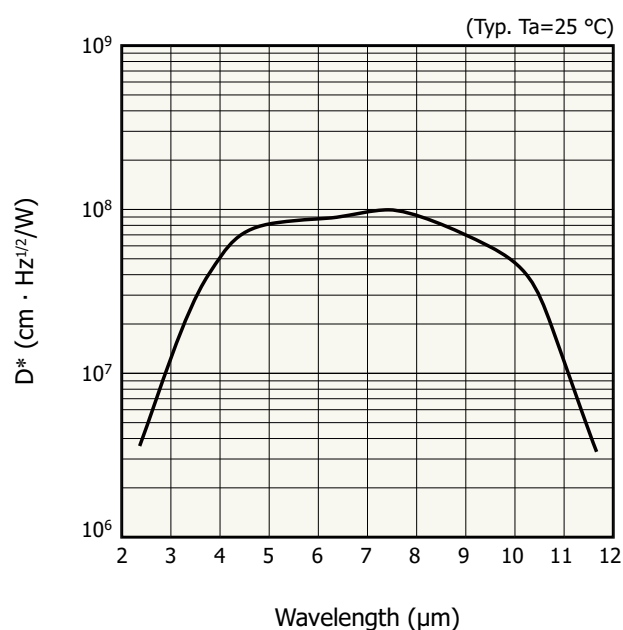
*2: P16614-011CN Reflow soldering, JEDEC J-STD-020 MLS 2, see P.6

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

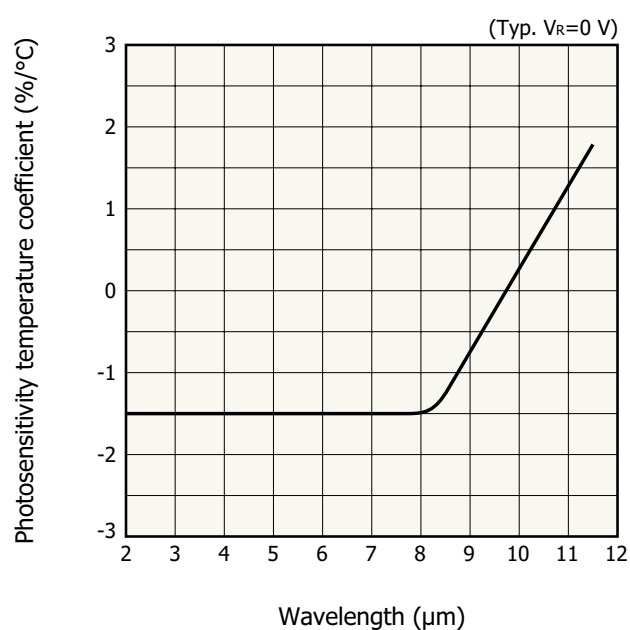
Electrical and optical characteristics (Ta=25 °C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|-----------------------------|-------------|--|-------------------|-----------------------|-----------------------|--|
| Peak sensitivity wavelength | λ_p | | - | 7.4 | - | μm |
| Cutoff wavelength | λ_c | | 9.7 | 11.0 | - | μm |
| Photosensitivity | S | $\lambda = \lambda_p$ | 3.4 | 5.0 | - | mA/W |
| Shunt resistance | Rsh | $V_R = 10 \text{ mV}$ | 0.65 | 1.3 | - | $\text{k}\Omega$ |
| Terminal capacitance | Ct | $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$ | - | 1.2 | - | pF |
| Detectivity | D^* | $(\lambda_p, 1200, 1)$ | 4.7×10^7 | 1.0×10^8 | - | $\text{cm}\cdot\text{Hz}^{1/2}/\text{W}$ |
| Noise equivalent power | NEP | $\lambda = \lambda_p$ | - | 7.1×10^{-10} | 9.0×10^{-10} | $\text{W}/\text{Hz}^{1/2}$ |
| Rise time | tr | $V_R = 0 \text{ V}$, $R_L = 50 \Omega$, 10 to 90% | - | 3 | 10 | ns |

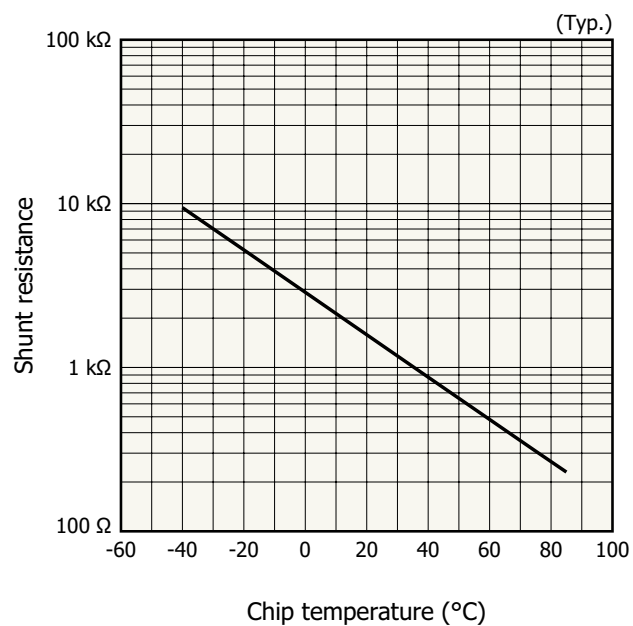
Spectral response (D^*)



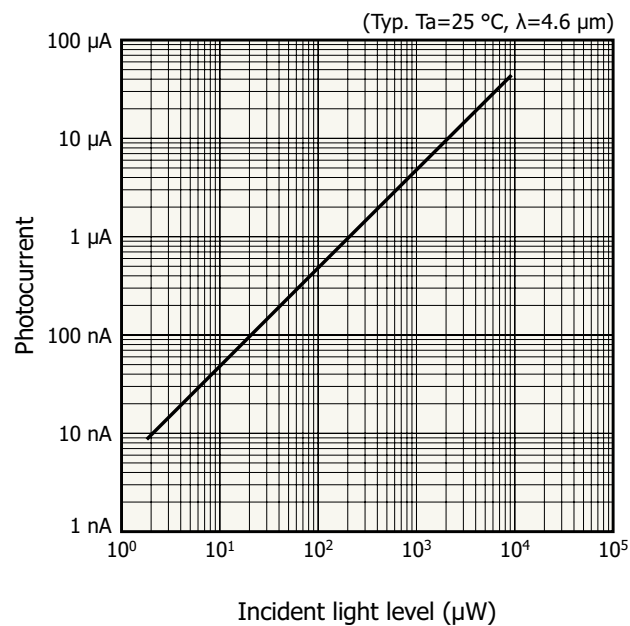
Photosensitivity temperature characteristics



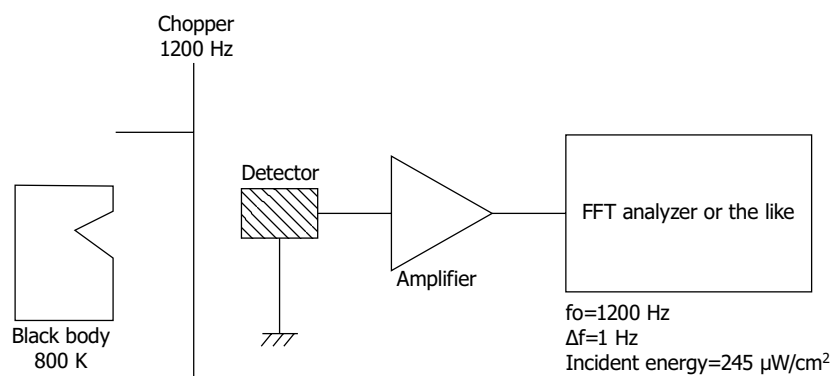
Shunt resistance vs. chip temperature



Linearity

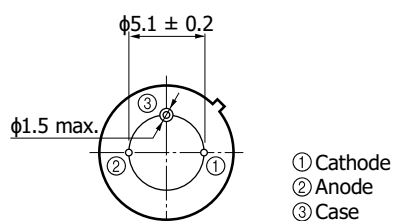
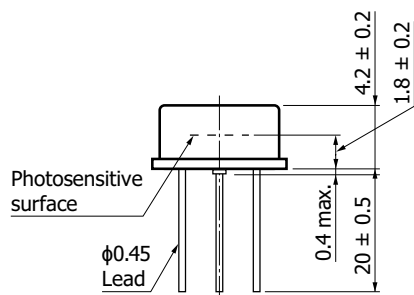
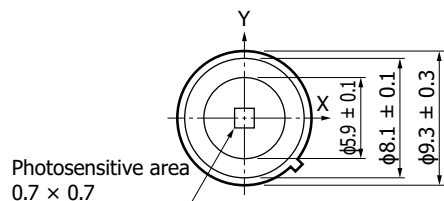


Block diagram for characteristic measurement



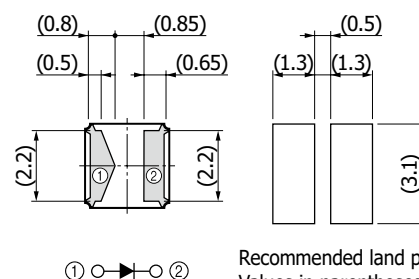
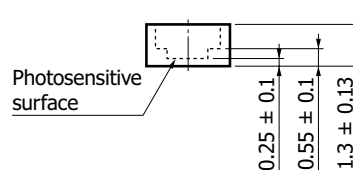
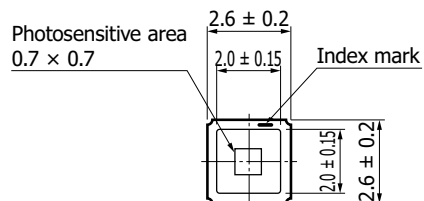
Dimensional outline (unit: mm)

P16114-011MN



KIRDA0290EA

P16614-011CN



Recommended land pattern
Values in parentheses
indicate reference values.

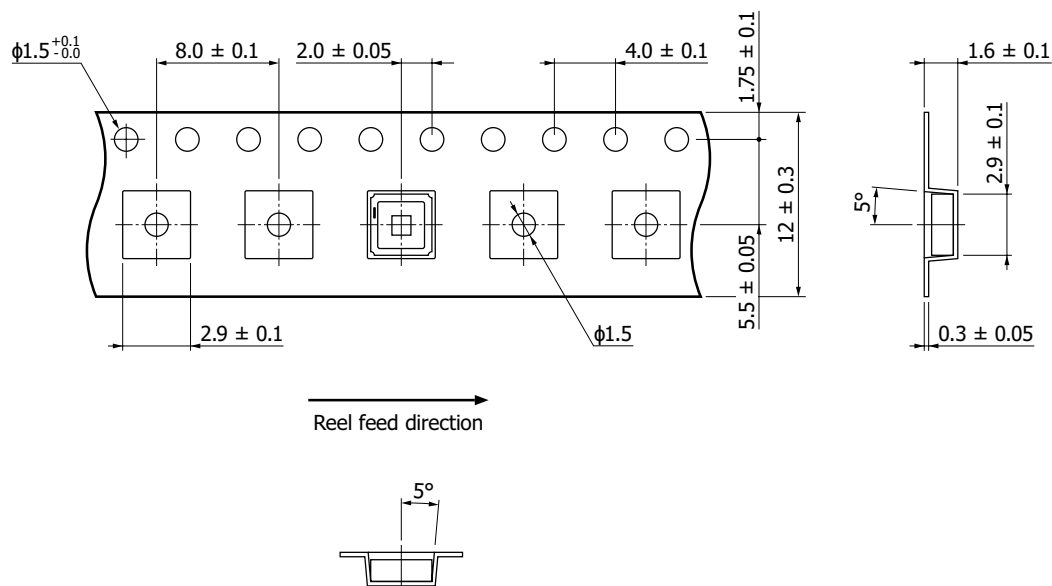
KIRDA0285EB

Standard packing specifications (P16614-011CN)

■ Reel (conforms to JEITA ET-7200)

| Outer diameter | Hub diameter | Tape width | Material | Electrostatic characteristics |
|----------------|--------------|------------|----------|-------------------------------|
| φ180 mm | φ60 mm | 12 mm | PS | Conductive |

■ Embossed tape (unit: mm, material: PS, conductive)



KLEDC0143EA

■ Packing quantity

100 pcs/reel

■ Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Recommended soldering conditions

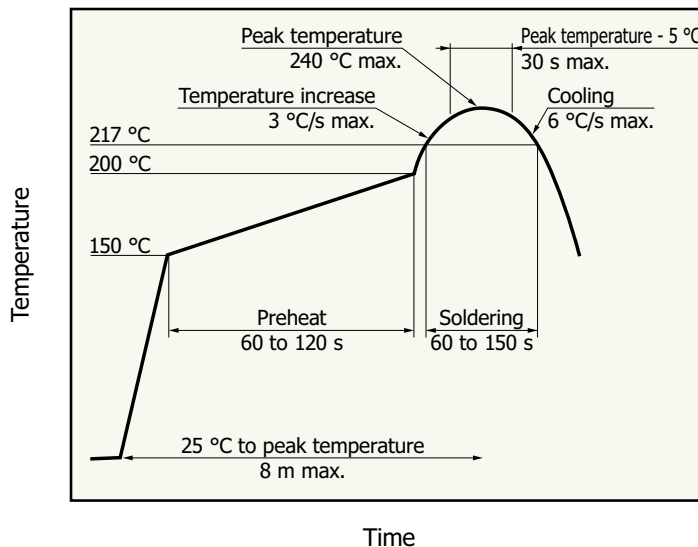
P16114-011MN

- Solder temperature: 260 °C (10 s or less, once)

Solder the leads at a point at least 1 mm away from the package body.

Note: When you set soldering conditions, check that problems do not occur in the product by testing out the condition in advance.

P16614-011CN



- After unpacking, store it in an environment at a temperature of 5 to 30 °C and a humidity of 60% or less, and perform reflow soldering within 1 year.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

KSPD80418EA

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

■ Precautions

- Disclaimer
- Safety consideration
- Surface mount type products
- Unsealed products
- Compound opto-semiconductors (photosensors, light emitters)

■ Technical note

- Compound semiconductor photosensors

The content of this document is current as of May 2024.

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HAMAMATSU

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HAMAMATSU PHOTONICS K.K., Solid State Division

1126-1 Ichino-cho, Chuo-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81)53-434-3311, Fax: (81)53-434-5184

U.S.A.: HAMAMATSU CORPORATION: 360 Foothill Road, Bridgewater, NJ 08807, U.S.A., Telephone: (1)908-231-0960, Fax: (1)908-231-1218

Germany: HAMAMATSU PHOTONICS DEUTSCHLAND GMBH: Arzbergerstr. 10, 82211 Herrsching am Ammersee, Germany, Telephone: (49)8152-375-0, Fax: (49)8152-265-8 E-mail: info@hamamatsu.de

France: HAMAMATSU PHOTONICS FRANCE S.A.R.L.: 19 Rue du Saule Trappu, Parc du Moulin de Massy, 91882 Massy Cedex, France, Telephone: (33)1 69 53 71 00, Fax: (33)1 69 53 71 10 E-mail: infos@hamamatsu.fr

United Kingdom: HAMAMATSU PHOTONICS UK LIMITED: 2 Howard Court, 10 Tewin Road, Welwyn Garden City, Hertfordshire, AL7 1BW, UK, Telephone: (44)1707-294888, Fax: (44)1707-325777 E-mail: info@hamamatsu.co.uk

North Europe: HAMAMATSU PHOTONICS NORDEN AB: Torshamnsgatan 35, 16440 Kista, Sweden, Telephone: (46)8-509-031-00, Fax: (46)8-509-031-01 E-mail: info@hamamatsu.se

Italy: HAMAMATSU PHOTONICS ITALIA S.R.L.: Strada della Moia, 1 int. 6 20044 Arese (Milano), Italy, Telephone: (39)02-93 58 17 33, Fax: (39)02-93 58 17 41 E-mail: info@hamamatsu.it

China: HAMAMATSU PHOTONICS (CHINA) CO., LTD.: 1201, Tower B, Jiaming Center, 27 Dongsanhuan Bellu, Chaoyang District, 100020 Beijing, P.R. China, Telephone: (86)10-6586-6006, Fax: (86)10-6586-2866 E-mail: hpc@hamamatsu.com.cn

Taiwan: HAMAMATSU PHOTONICS TAIWAN CO., LTD.: 13F-1, No.101, Section 2, Gongdao 5th Road, East Dist., Hsinchu City, 300046, Taiwan(R.O.C) Telephone: (886)3-659-0080, Fax: (886)3-659-0081 E-mail: info@hamamatsu.com.tw